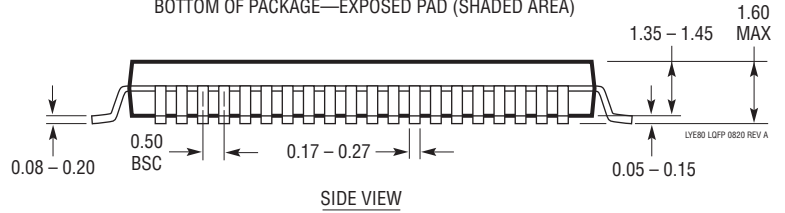
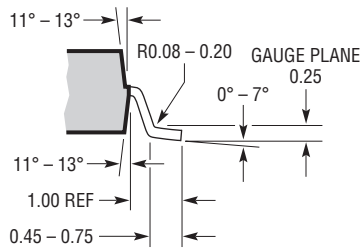
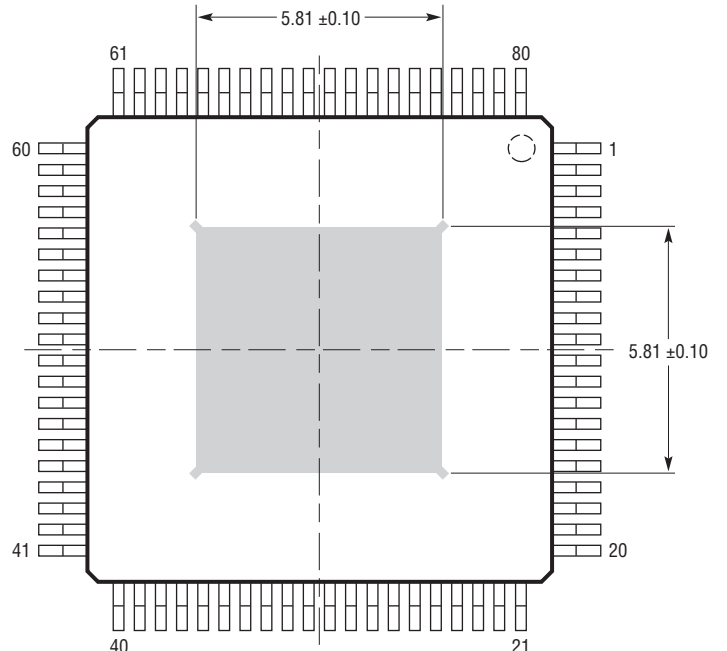
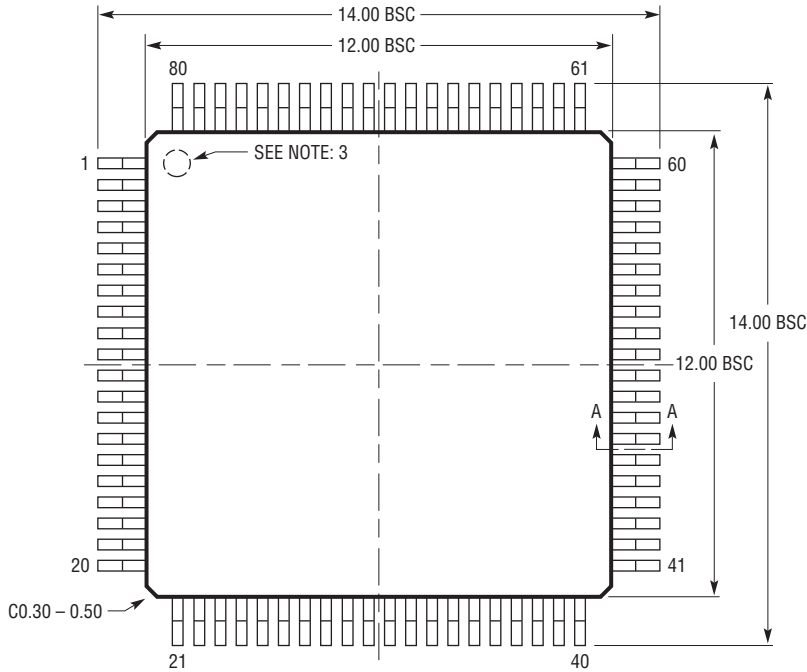


LYE Package
80-Lead Plastic Exposed Pad LQFP (12mm × 12mm)
 (Reference LTC DWG #05-08-1783 Rev A)

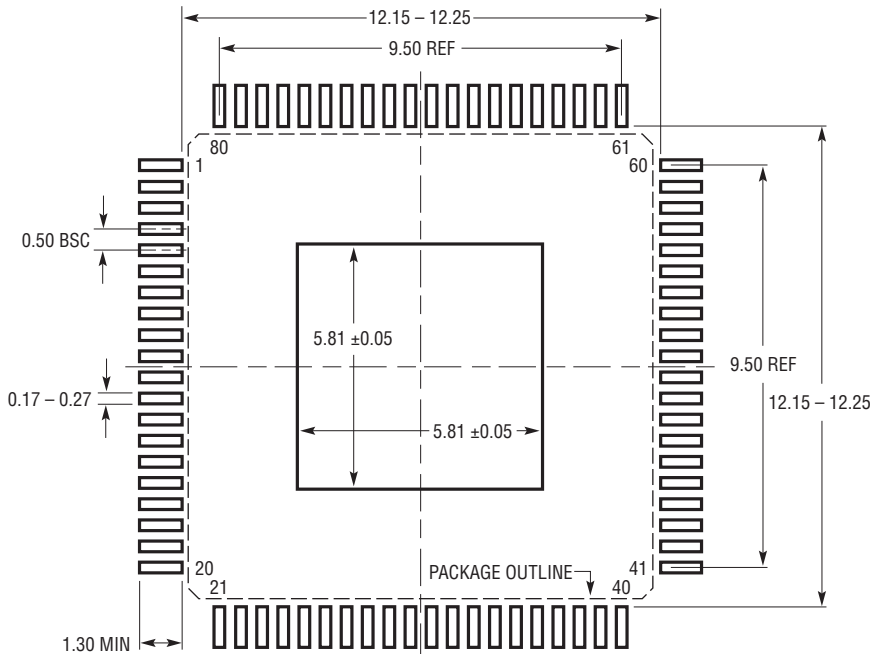


SECTION A - A

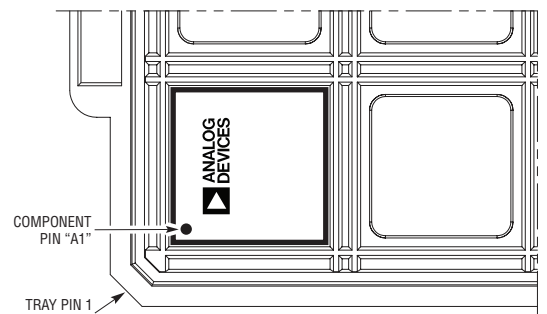
SIDE VIEW

NOTE:

1. DIMENSIONS ARE IN MILLIMETERS
2. DIMENSIONS OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.25mm (10 MILS) BETWEEN THE LEADS AND ON ANY SIDE OF EXPOSED PAD, MAX 0.50mm (20 MILS) AT CORNER OF EXPOSED PAD, IF PRESENT
3. PIN-1 IDENTIFIER IS A MOLDED INDENTATION
4. DRAWING IS NOT TO SCALE



RECOMMENDED SOLDER PAD LAYOUT
 APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED



PACKAGE IN TRAY LOADING ORIENTATION